

SL-SMT 5.08HC/16/180 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

High-temperature-resistant, straight, open pin header.
Packed in box or tape. On tape and with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, open side, THT/THR solder connection, 5.08 mm, Number of poles: 16, 180°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1838120000
Type	SL-SMT 5.08HC/16/180 3.2SN BK BX
GTIN (EAN)	4032248348183
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date May 23, 2024 11:00:09 AM CEST

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Technical data

Dimensions and weights

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Width	81.28 mm
Width (inches)	3.2 inch	Net weight	6 g

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.08	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5.08 mm
Pitch in inches (P)	0.2 "	Outgoing elbow	180°
Number of poles	16	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.5 mm
Solder eyelet hole diameter tolerance (D)+ 0,1 mm		L1 in mm	76.2 mm
L1 in inches	3 "	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	finger-safe unplugged/ back-of-hand-safe plugged
Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged	Protection degree	IP20
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	9 N	Pulling force/pole, max.	7 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		

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Technical data**Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1176845

Rated voltage (Use group B / CSA) 300 V

Rated voltage (Use group D / CSA) 300 V

Rated current (Use group D / CSA)
18.5 AReference to approval values
Specifications are maximum values, details - see approval certificate.**Rated data acc. to UL 1059**

Institute (UR)



Certificate No. (UR)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group B / UL 1059) 18.5 A

Rated current (Use group D / UL 1059) 10 A

Reference to approval values
Specifications are maximum values, details - see approval certificate.**Packing**

Packaging	Box	VPE length	225 mm
VPE width	110 mm	VPE height	45 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
ECLASS 12.0	27-46-02-01	ECLASS 13.0	27-46-02-01

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Technical data

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	<ul style="list-style-type: none"> • Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet $D = 1.4 + 0.1 \text{ mm}$ • Solder eyelet diameter $D = 1.5 + 0.1 \text{ mm}$, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals

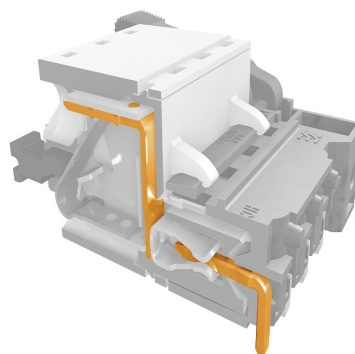
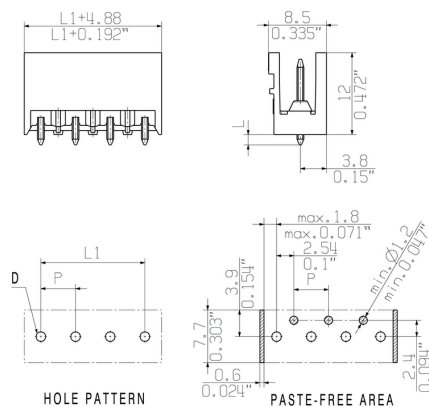
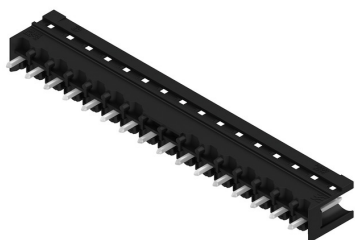


ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

Downloads

Approval/Certificate/Document of Conformity	CB Certificate CB Testreport Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN MB SMT EN FL DRIVES DE MB DEVICE MANUF. EN FL BUILDING SAFETY EN FL APPL LED LIGHTING EN FL INDUSTR.CONTROLS EN FL MACHINE SAFETY EN FL HEATING ELECTR EN FL APPL INVERTER EN FL_BASE_STATION_EN FL ELEVATOR EN FL POWER SUPPLY EN FL 72H SAMPLE SER EN PO OMNIMATE EN PO OMNIMATE EN
White paper surface mount technology	Download Whitepaper

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Accessories

Coding elements

**Only connects what is supposed to be connected: the right connection at the right place.**

Coding elements and locking devices clearly assign connecting elements during the manufacturing process and operation

The coding elements and locking devices are inserted prior to assembly or during the cable assembly phase. The Weidmüller alternative: configure online using the variant configurator to precode prior to delivery.

Incorrect assembly on the circuit board and incorrect plugging of connecting elements is no longer possible. The advantage: no troubleshooting during manufacture and no operational errors by the user.

General ordering data

Type	BLZ/SL KO OR BX	Version	Product data	Packaging
Order No.	1573010000	PCB plug-in connector, Accessories, Coding element, orange, Number		Box
GTIN (EAN)	4008190048396	of poles: 1		
Qty.	100 pc(s).			
Type	BLZ/SL KO BK BX	Version	Product data	Packaging
Order No.	1545710000	PCB plug-in connector, Accessories, Coding element, black, Number		Box
GTIN (EAN)	4008190087142	of poles: 1		
Qty.	50 pc(s).			

Additional accessories

**No task is too small when creating the perfect solution.**

Connections form just one part of the overall process. Small details are often the key to the perfect solution in applications where potentials are tested, grouped or even isolated.

A system is not a system without small but useful details:

- Test plugs - ensure reliable pick-up from diagnostic sockets
- Cross-connectors - ensure a stable electrical distribution contact directly at the connection
- Compartment partition elements - divide a large number of male connectors into several separate socket connector channels
- Locks and clips - optional vibration-resistant clip-on connection or mounting for male and female connectors

In tandem with the manufacturing process and application - more accessories = smaller workload

General ordering data

Type	SL AT OR	Version	Product data	Packaging
Order No.	1598300000	PCB plug-in connector, Accessories, Spacer, orange, Number of poles:		Box
GTIN (EAN)	4008190189266	1		
Qty.	100 pc(s).			

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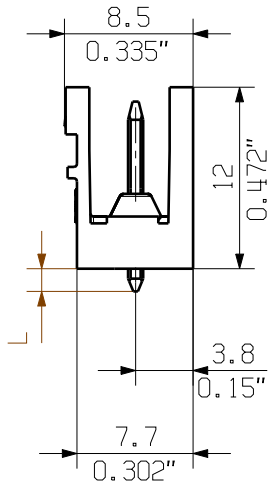
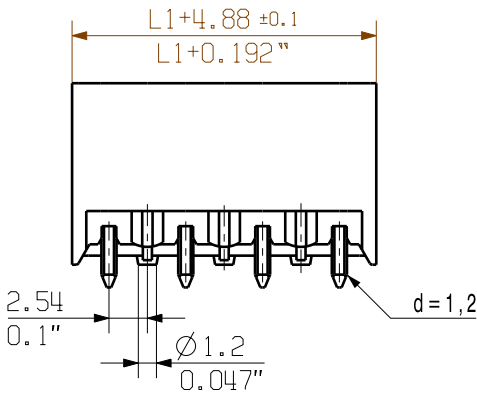
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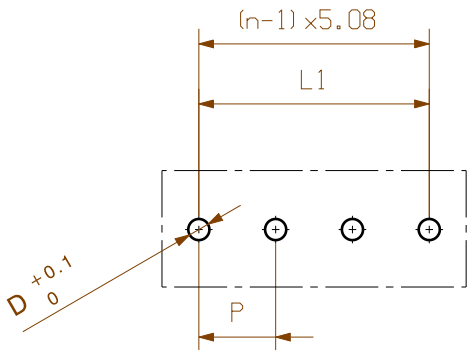
Germany

www.weidmueller.com**Accessories**

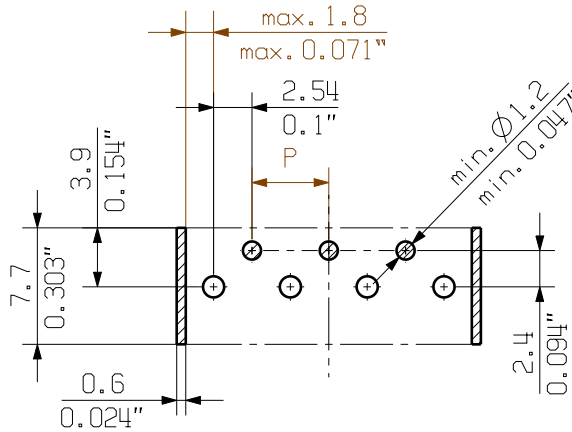
Type	SL AT SW	Version	Product data	Packaging
Order No.	1770240000	PCB plug-in connector, Accessories, Spacer, black, Number of poles: 1		Box
GTIN (EAN)	4032248117710			
Qty.	100 pc(s).			



M 1:1



HOLE PATTERN



PASTE-FREE AREA

D= 1.4/0.055" or 1.5/0.059"(REFLOW SOLDERING)
RECOMMENDATION FOR AUTOMATIC ASSEMBLY
(1.4mm FOR n=2...8 / 1.5mm for n=9...24)

n= POLZAHL/NO OF POLES

P=RASTER/PITCH

SHOWN: SL-SMT 5.08HC/04/180

1,5	0,0	24	116,84	4,600
	-0,3	23	111,76	4,400
3,2	0,1	22	106,68	4,200
	-0,3	21	101,60	4,000
4,5	0,1	20	96,52	3,800
	-0,3	19	91,44	3,600
STIFTLAENGE L	TOLERANZ	18	86,36	3,400
		17	81,28	3,200
n	L1 [mm]	16	76,20	3,000
	L1 [Inch]	15	71,12	2,800
		14	66,04	2,600
		13	60,96	2,400
		12	55,88	2,200
		11	50,80	2,000
		10	45,72	1,800
		9	40,64	1,600
		8	35,56	1,400
		7	30,48	1,200
		6	25,40	1,000
		5	20,32	0,800
		4	15,24	0,600
		3	10,16	0,400
		2	5,08	0,200

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.
The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.
The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application.
Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

	DIN ISO 2768-m		106339/4 30.07.18 HERTEL_S		00	Weidmüller		Cat.no.: .	
	Modification							C 34148	
	Drawn	30.11.2007	HELIS_MA		HERTEL_S		Drawing no.		Issue no.
	Responsible						Sheet 01		of 04 sheets
	Checked	01.08.2018	KOCH_JG						
Scale: 2:1		Approved		LANG_T					
Supersedes: .									

Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.